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United States Patent and Trademark Office

COMMISSIONER FOR PATENTS UNITED STATES PATENT AND TRADEMARK OFFICE Washington, D.C. 20231

APPLICATION NUMBER

FILING/RECEIPT DATE

FIRST NAMED APPLICANT

ATTORNEY DOCKET NUMBER

10/022,605

12/17/2001

Klemens Ferstl

WMP-SME-352

LERNER AND GREENBERG, P.A.

PATENT ATTORNEYS AND ATTORNEYS AT LAW

Post Office Box 2480 Hollywood, FL 33022-2480



CONFIRMATION NO. 2348

FORMALITIES LETTER

Date Mailed: 01/17/2002

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below. however, are missing. Applicant is given TWO MONTHS from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The oath or declaration is unsigned.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(I) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
- The balance due by applicant is \$ 130.

A copy of this notice <u>MUST</u> be returned with the reply.

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Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

03/06/2002 JBALINAN 00000017 10022605

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Docket No.:

WMP-SME-352

I hereby certify that this correspondence is being deposited with the United States Postate rvice with sufficient class mail in any envelope addressed to: Assistant Commissioner for Patents, Weshington, D.C. 20231... vice with sufficient postage as

Date: February 14, 2002

UNITED STATES PATENT AND TRADEMARK OFFICE

COPY OF PAPERS ORIGINALLY FILED

Applicant

Klemens Ferstl et al.

Appl. No.

10/022,605

Filed

December 17, 2001

Title

Multichip Module for LOC Mounting and Method for Producing the

Multichip Module

Art Unit

2811

LETTER

Hon. Commissioner of Patents and Trademarks, Washington, D.C. 20231

Sir:

The above-mentioned new patent application was filed on December 17, 2001 without a signed oath or declaration, under the provision of 37 C.F.R. 1.53(f).

In accordance with the above-mentioned rule, enclosed herewith is the original signed declaration as required by the Notice To File Missing Parts Of Application dated January 17,

The undersigned hereby states that the application filed in the Patent and Trademark Office is the application which the inventor(s) executed by signing the declaration. 601.01(a).

The fee required for the late filing of an oath or declaration in the amount of \$130.00 is also

Respectfully submitted,

MAYBACK.

/mib

Date: February 14, 2002 Lerner and Greenberg, P.A. Post Office Box 2480

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